

# Standard Rectifier

**V<sub>RRM</sub>** = 2x 1200 V

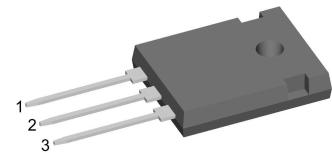
**I<sub>FAV</sub>** = 50 A

**V<sub>F</sub>** = 1.28 V

## Phase leg

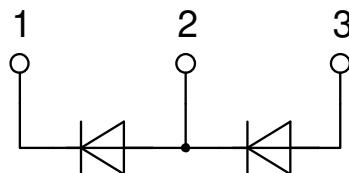
### Part number

**DMA50P1200HR**



Backside: isolated

 E72873



### Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour
- High commutation robustness
- High surge capability

### Applications:

- Diode for main rectification
- For single and three phase bridge configurations

### Package: ISO247

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling

### Disclaimer Notice

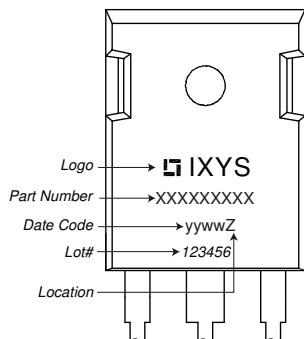
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**Rectifier**

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$V_{RSM}$	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1300	V
$V_{RRM}$	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			1200	V
$I_R$	reverse current	$V_R = 1200 \text{ V}$ $V_R = 1200 \text{ V}$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 150^\circ C$		40 1.5	$\mu A$ mA
$V_F$	forward voltage drop	$I_F = 50 \text{ A}$ $I_F = 100 \text{ A}$ $I_F = 50 \text{ A}$ $I_F = 100 \text{ A}$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 150^\circ C$		1.31 1.64 1.28 1.70	V V
$I_{FAV}$	average forward current	$T_C = 105^\circ C$ $180^\circ \text{ sine}$	$T_{VJ} = 175^\circ C$		50	A
$V_{F0}$ $r_F$	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 175^\circ C$		0.82 9	V $m\Omega$
$R_{thJC}$	thermal resistance junction to case				0.7	K/W
$R_{thCH}$	thermal resistance case to heatsink			0.3		K/W
$P_{tot}$	total power dissipation		$T_C = 25^\circ C$		210	W
$I_{FSM}$	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$ $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$ $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$ $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$T_{VJ} = 45^\circ C$ $V_R = 0 \text{ V}$ $T_{VJ} = 150^\circ C$ $V_R = 0 \text{ V}$		650 700 555 595	A
$I^2t$	value for fusing	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$ $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$ $t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}$ $t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{sine}$	$T_{VJ} = 45^\circ C$ $V_R = 0 \text{ V}$ $T_{VJ} = 150^\circ C$ $V_R = 0 \text{ V}$		2.12 2.04 1.54 1.48	kA <sup>2</sup> s kA <sup>2</sup> s kA <sup>2</sup> s kA <sup>2</sup> s
$C_J$	junction capacitance	$V_R = 400 \text{ V}; f = 1 \text{ MHz}$	$T_{VJ} = 25^\circ C$	18		pF

Package ISO247			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	<i>RMS current</i>	per terminal			70	A
$T_{VJ}$	<i>virtual junction temperature</i>		-55		175	°C
$T_{op}$	<i>operation temperature</i>		-55		150	°C
$T_{stg}$	<i>storage temperature</i>		-55		150	°C
<b>Weight</b>				6		g
$M_d$	<i>mounting torque</i>		0.8		1.2	Nm
$F_c$	<i>mounting force with clip</i>		20		120	N
$d_{Spp/App}$	<i>creepage distance on surface / striking distance through air</i>		terminal to terminal	2.7		mm
$d_{Spb/Apb}$			terminal to backside	4.1		mm
$V_{ISOL}$	<i>isolation voltage</i>	$t = 1 \text{ second}$ $t = 1 \text{ minute}$	50/60 Hz, RMS; $I_{ISOL} \leq 1 \text{ mA}$	3600 3000		V V

### Product Marking



### Part description

D = Diode  
M = Standard Rectifier  
A = (up to 1800V)  
50 = Current Rating [A]  
P = Phase leg  
1200 = Reverse Voltage [V]  
HR = ISO247 (3)

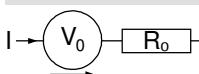
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DMA50P1200HR	DMA50P1200HR	Tube	30	512335

Similar Part	Package	Voltage class
DMA50P1200HB	TO-247AD (3)	1200

### Equivalent Circuits for Simulation

\* on die level

$T_{VJ} = 175^\circ\text{C}$

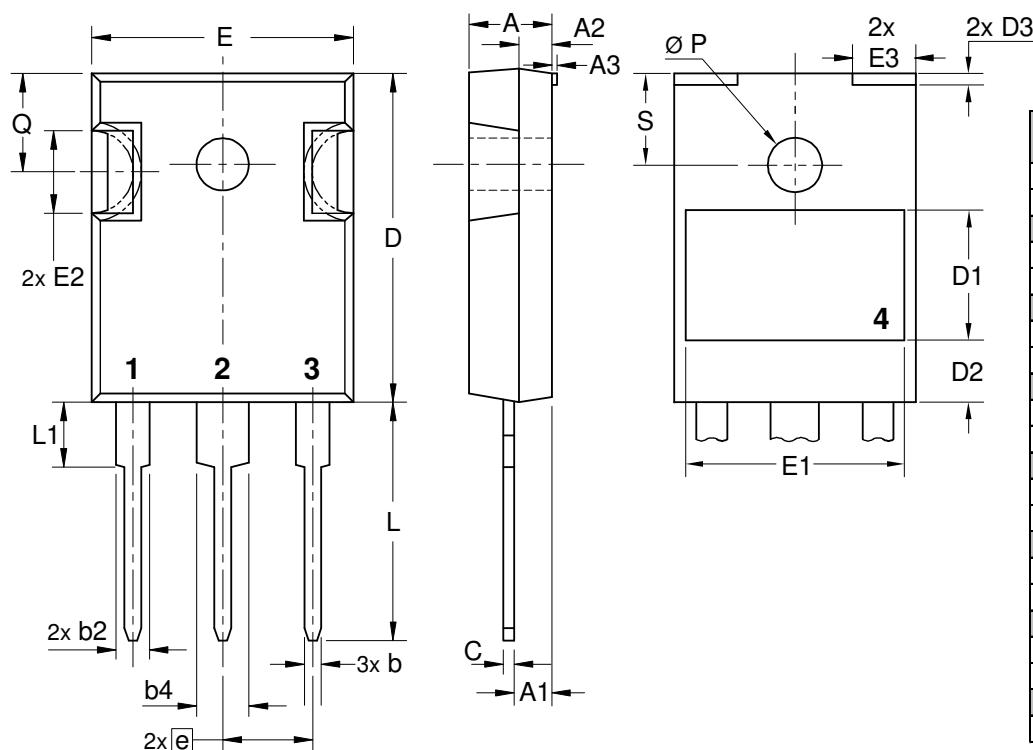


Rectifier

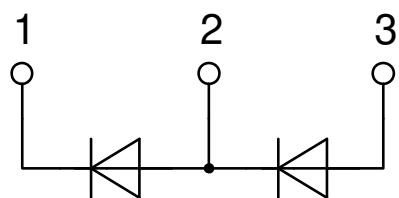
$V_{0\ max}$  threshold voltage 0.82  
 $R_{0\ max}$  slope resistance \* 6.4

V

mΩ

**Outlines ISO247**


Dim.	Millimeter		Inches	
	min	max	min	max
A	4.70	5.30	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
A3	typ. 0.05		typ. 0.002	
b	0.99	1.40	0.039	0.055
b2	1.65	2.39	0.065	0.094
b4	2.59	3.43	0.102	0.135
c	0.38	0.89	0.015	0.035
D	20.79	21.45	0.819	0.844
D1	typ. 8.90		typ. 0.350	
D2	typ. 2.90		typ. 0.114	
D3	typ. 1.00		typ. 0.039	
E	15.49	16.24	0.610	0.639
E1	typ. 13.45		typ. 0.530	
E2	4.31	5.48	0.170	0.216
E3	typ. 4.00		typ. 0.157	
e	5.46	BSC	0.215	BSC
L	19.80	20.30	0.780	0.799
L1	-	4.49	-	0.177
Ø P	3.55	3.65	0.140	0.144
Q	5.38	6.19	0.212	0.244
S	6.14	BSC	0.242	BSC



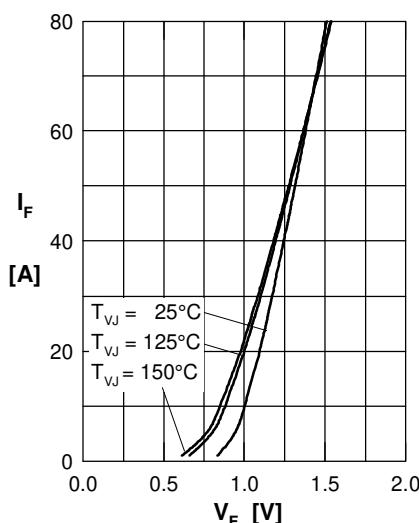
**Rectifier**


Fig. 1 Forward current versus voltage drop per diode

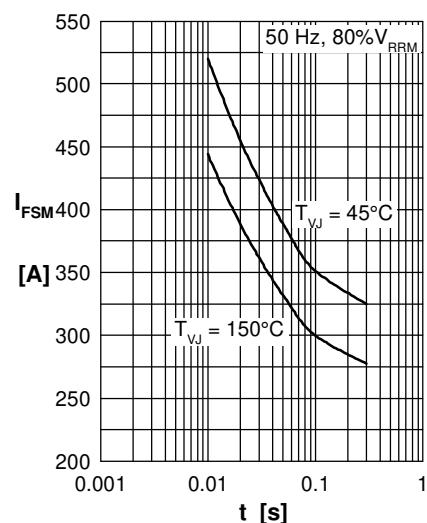


Fig. 2 Surge overload current versus time per diode

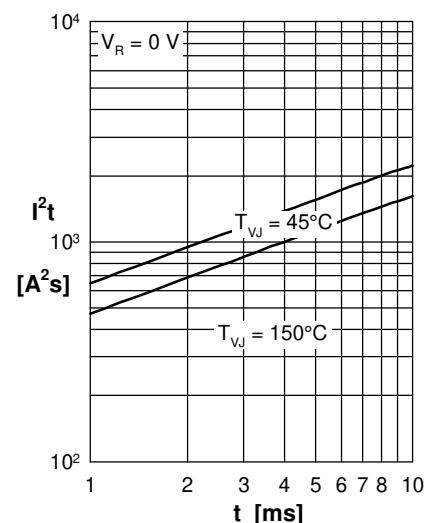


Fig. 3  $I^2t$  versus time per diode

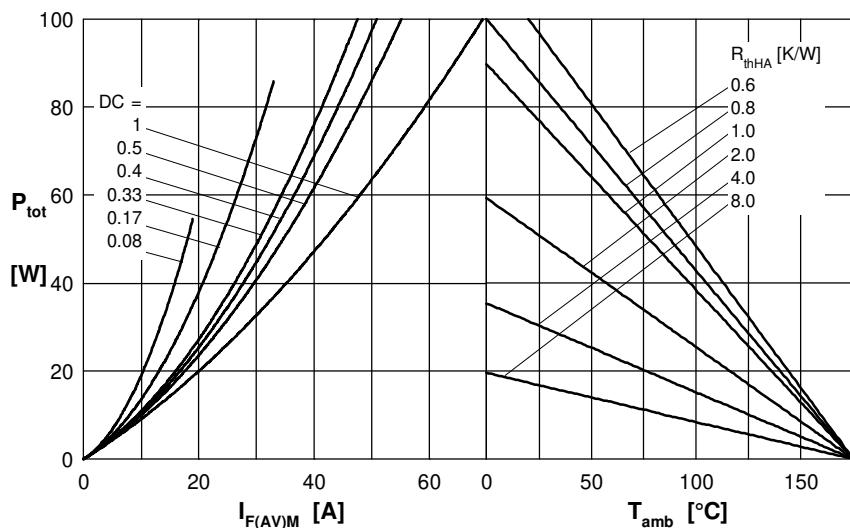


Fig. 4 Power dissipation versus direct output current and ambient temperature per diode

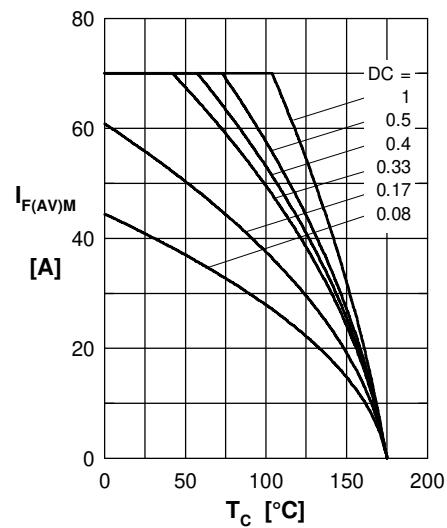


Fig. 5 Max. forward current vs. case temperature per diode

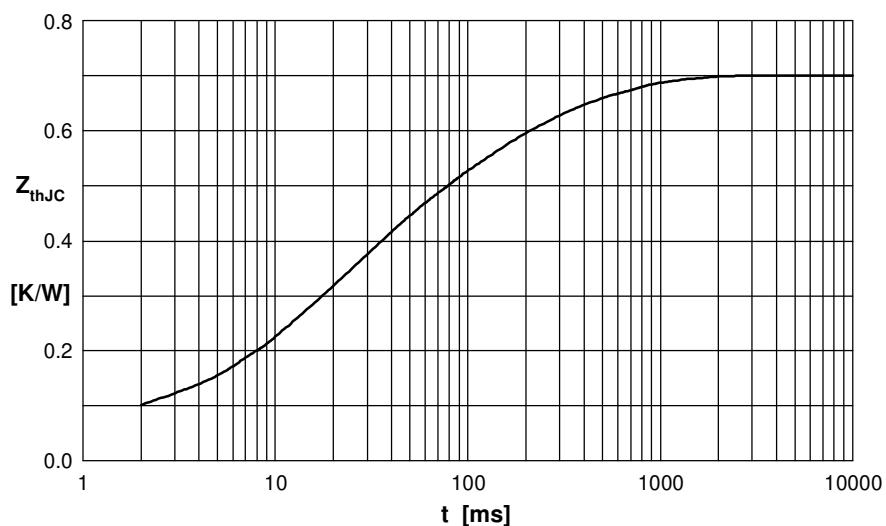


Fig. 6 Transient thermal impedance junction to case versus time per diode

Constants for  $Z_{thJC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.06	0.0004
2	0.12	0.0100
3	0.20	0.0240
4	0.20	0.1000
5	0.12	0.4500